# **DATA SHEET**



# MOS FIELD EFFECT TRANSISTOR 2SK2511

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK2511 is N-Channel MOS Field Effect Transistor designed for high current switching applications.

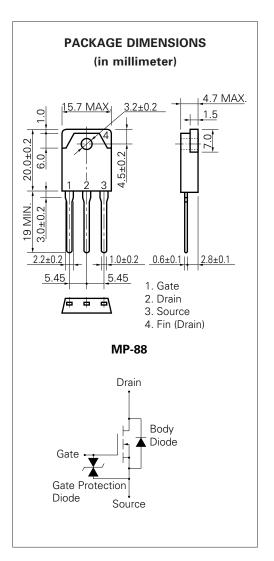
#### **FEATURES**

- Super Low On-Resistance
  - $R_{DS\;(on)1}$  = 27  $m\Omega$  (Vgs = 10 V, Ip = 20 A)
  - RDS (on)2 = 40 m $\Omega$  (VGS = 4 V, ID = 20 A)
- Low Ciss Ciss = 1 210 pF TYP.
- · Built-in G-S Protection Diode

## ABSOLUTE MAXIMUM RATINGS (TA = 25 °C)

Drain to Source Voltage	$V_{\text{DSS}}$	60	V
Gate to Source Voltage	Vgss	±20	V
Drain Current (DC)	ID (DC)	±40	Α
Drain Current (pulse)*	ID (pul	se) ±160	Α
Total Power Dissipation (Tc = 25 °C)	P <sub>T1</sub>	80	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	$P_{T2}$	3.0	W
Channel Temperature	$T_ch$	150	°C
Storage Temperature	$T_{stg}$	-55 to +150	°C

\* PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1 %



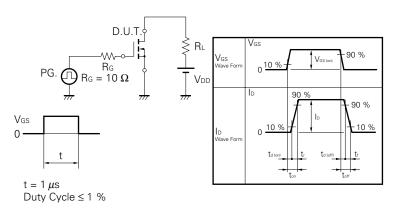
The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device is actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.



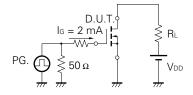
## ELECTRICAL CHARACTERISTICS (TA = 25 °C)

CHARACTERISTIC	SYMBOL	MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Drain to Source On-Resistance	RDS (on)1		22	27	mΩ	Vgs = 10 V, ID = 20 A
Drain to Source On-Resistance	RDS (on)2		32	40	mΩ	Vgs = 4 V, ID = 20 A
Gate to Source Cutoff Voltage	Vgs (off)	1.0	1.5	2.0	V	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA
Forward Transfer Admittance	yfs	10			S	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 20 A
Drain Leakage Current	IDSS			10	μΑ	V <sub>DS</sub> = V <sub>DSS</sub> , V <sub>GS</sub> = 0
Gate to Source Leakage Current	Igss			±10	μΑ	$V_{GS} = \pm 20 \text{ V, } V_{DS} = 0$
Input Capacitance	Ciss		1 210		pF	V <sub>DS</sub> = 10 V
Output Capacitance	Coss		610		pF	Vgs = 0
Reverse Transfer Capacitance	Crss		270		pF	f = 1 MHz
Turn-On Delay Time	td (on)		32		ns	ID = 20 A
Rise Time	tr		300		ns	Vgs = 10 V
Turn-Off Delay Time	td (off)		160		ns	V <sub>DD</sub> = 30 V
Fall Time	tf		220		ns	$R_G = 10 \Omega$
Total Gate Charge	<b>Q</b> G		50		nC	ID = 40 A
Gate to Source Charge	Qgs		4.5		nC	V <sub>DD</sub> = 48 V
Gate to Drain Charge	Q <sub>GD</sub>		21		nC	V <sub>GS</sub> = 10 V
Body Diode Forward Voltage	VF (S-D)		1.0		V	IF = 40 A, VGS = 0
Reverse Recovery Time	trr		70		ns	IF = 40 A, VGS = 0
Reverse Recovery Charge	Qrr		140		nC	di/dt = 100 A/μs

## **Test Circuit 1 Switching Time**



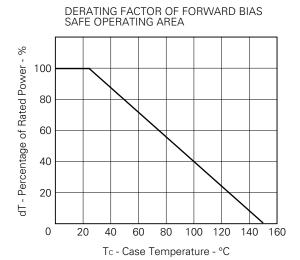
## **Test Circuit 2 Gate Charge**

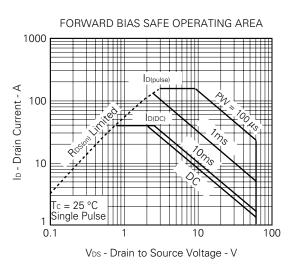


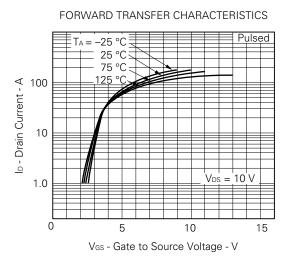
The application circuits and their parameters are for references only and are not intended for use in actual design-in's.

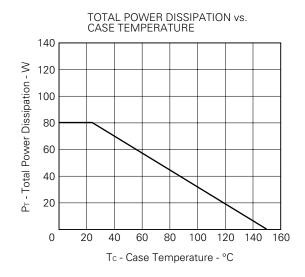
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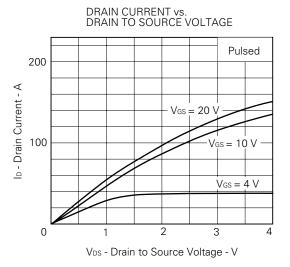
## TYPICAL CHARACTERISTICS (TA = 25 °C)



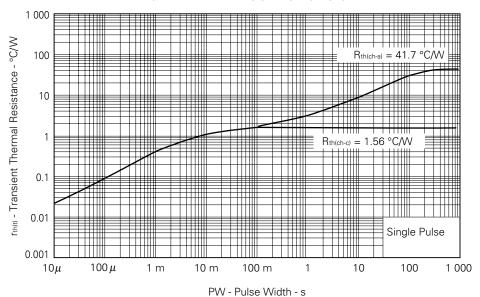






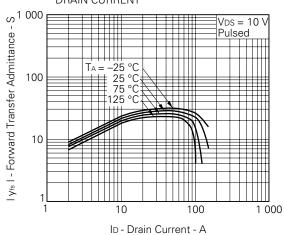


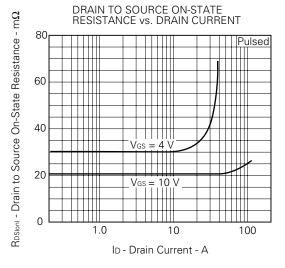
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH



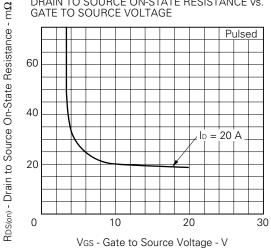
FORWARD TRANSFER ADMITTANCE vs. **DRAIN CURRENT** 

**NEC** 

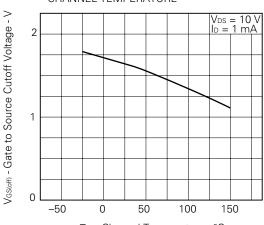


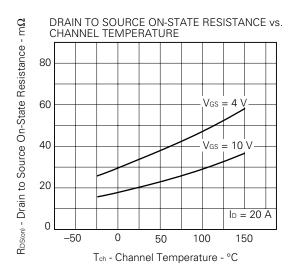


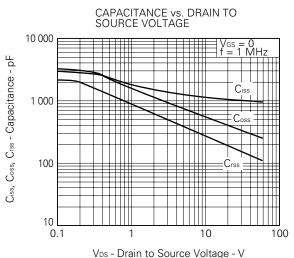
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

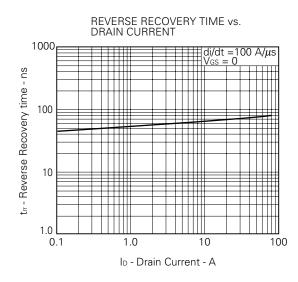


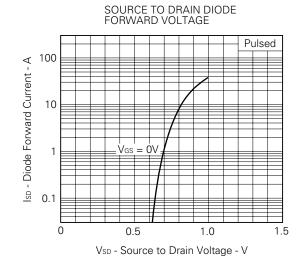
GATE TO SOURCE CUTOFF VOLTAGE vs. CHANNEL TEMPERATURE

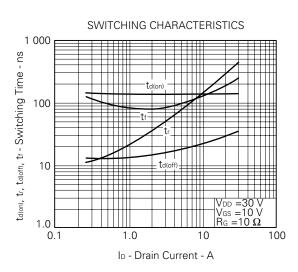


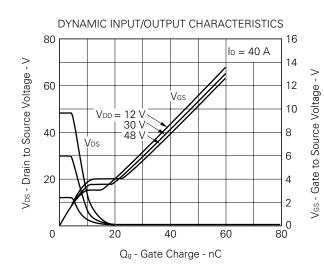














# REFERENCE

Document Name	Document No.	
NEC semiconductor device reliability/quality control system.	TEI-1202	
Quality grade on NEC semiconductor devices.	IEI-1209	
Semiconductor device mounting technology manual.	IEI-1207	
Semiconductor device package manual.	IEI-1213	
Guide to quality assurance for semiconductor devices.	MEI-1202	
Semiconductor selection guide.	MF-1134	
Power MOS FET features and application switching power supply.	TEA-1034	
Application circuits using Power MOS FET.	TEA-1035	
Safe operating area of Power MOS FET.	TEA-1037	

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[MEMO]

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